

Absolute	Maximum Ratings	T_c = 25 °C, unless otherwise specified					
Symbol	Conditions	Values	Units				
V_{DS}		200	V				
ID	T _s = 25 (80) °C	180 (135)	Α				
	1 ms	540	Α				
I _{DM} V _{GS}		± 20	V				
T_{vj} , (T_{stg})		- 40 + 150 (125)	°C				
V _{isol}	AC, 1 min.	2500	V				
Inverse diode							
I _F = - I _S		180	Α				
$I_{FM} = -I_{SM}$		540	Α				

Power MOSFET Modules

SKM 180A020

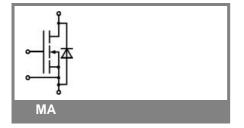
Features

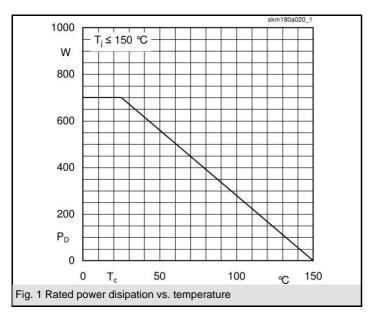
- N Channel, enhancement mode
- Avalanche characteristics
- Short internal connections avoid oscillations
- · Isolated copper baseplates
- All electrical connections on top for easy busbaring
- Large clearance (10mm) and creepage distances (13mm)
- UL recognized, file no. E 63 532

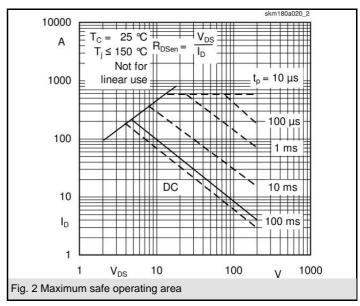
Typical Applications

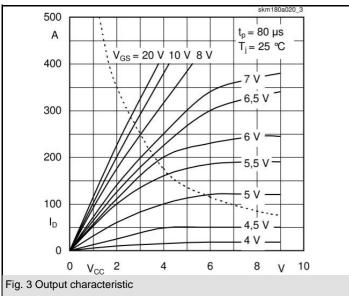
- Switched mode power supplies
- DC servo and robot drives
- · DC choppers
- UPS equipment
- · Plasma cutting
- Not suitable for linear amplification

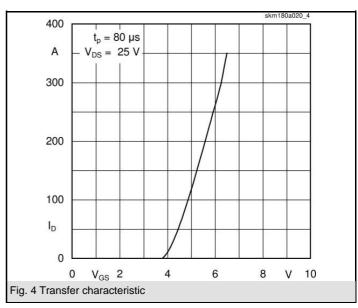
Characte	istics	T _c = 25 °C, unless otherwise specified				
Symbol	Conditions	min.	typ.	max.	Units	
V _{(BR)DSS}	$V_{GS} = 0 \text{ V}, I_{D} = 0.25 \text{ mA}$	200	,,,	maxi	V	
V _{GS(th)}	$V_{GS} = V_{DS}$, $I_D = 1 \text{ mA}$	2,1	3	4	V	
I _{DSS}	V _{GS} = 0 V, V _{DS} = 200 V, T _i = 25 (125) °C		50 (300)	250 (1000)	μΑ	
I _{GSS}	$V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$		10	100	nA	
R _{DS(on)}	V _{GS} = 10 V, I _D = 110 A		9	11	mΩ	
g _{fs}	V _{DS} = 25 V, I _D = 110 A	80	100		S	
C _{CHC}	V _{GS} = 0, V _{DS} = 25 V, f = 1 MHz			160	pF	
C _{iss}			16	24	nF	
C _{oss}			3	4,5	nF	
C _{rss}			1,5	2	nF	
L _{DS}				20	nΗ	
t _{d(on)}	V _{DD} = 100 V, I _D = 80 A,		100		ns	
t _r `´	$V_{GS} = 10 \text{ V}, R_{G} = 3.3 \Omega$		200		ns	
$t_{d(off)}$			900		ns	
t _f			220		ns	
Inverse diode						
V_{SD}	I _F = 360 A; V _{GS} = 0 V		1,3	1,5	V	
t _{rr}	T _j = 25 (125) °C		0,5		ns	
Q_{rr}	T _j = 25 °C		10 (12)		μC	
I _{rr}	$T_j = {^{\circ}C}$				Α	
Thermal of	characteristics					
R _{th(j-c)}	per MOSFET			0,18	K/W	
R _{th(c-s)}	$\rm M_{\rm s}$, surface 10 $\mu \rm m$, per module			0,05	K/W	
Mechanical data						
M_s	to heatsink (M6)	4		5	Nm	
M _t	for terminals (M5)				Nm	
w				130	g	

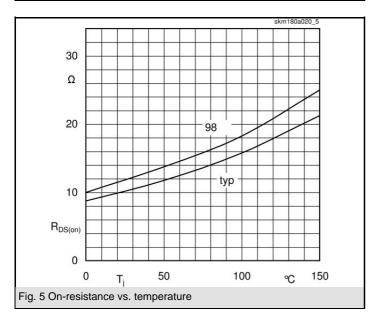


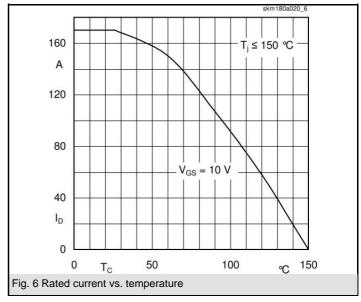


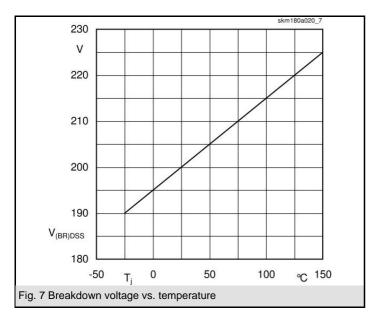


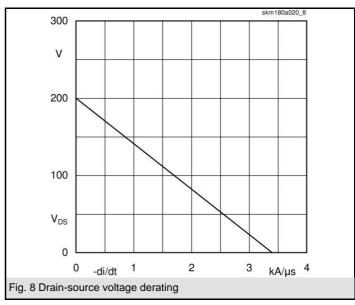


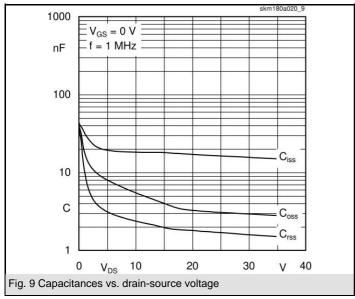


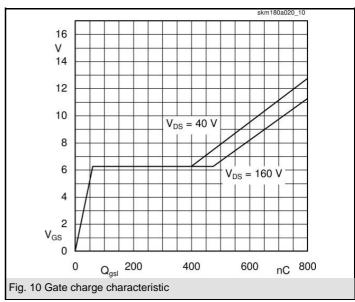


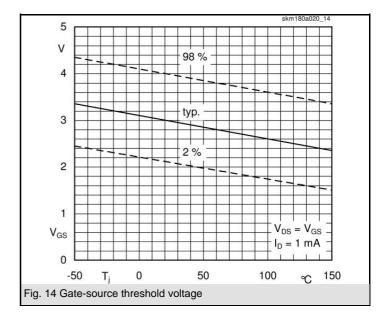


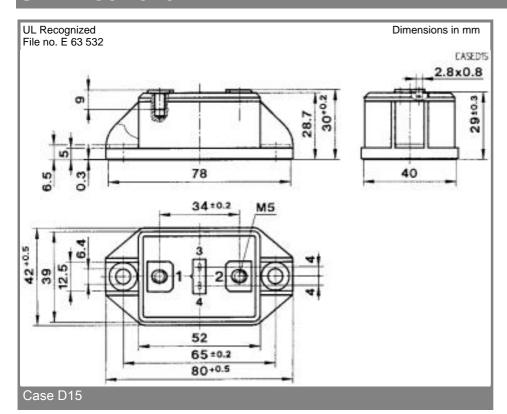


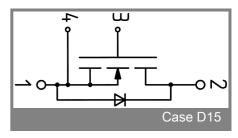












This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

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